



CBR-SMD RF COG, Ceramic, 91 pF, 1%, 100 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	12.03 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

91pF 1%

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.85mm +/-0.1mm
В	0.5mm +/-0.2mm

W	1.25mm +/-0.2mm	Voltage DC	100 VDC
Т	0.85mm +/-0.1mm	Dielectric Withstanding Voltage	250 VDC
B 0.5mm +/-0.2mm	0.5mm +/-0.2mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Dissipation Factor	0.1%
Packaging	T&R, 180mm, Plastic Tape	Aging Rate	0% Loss/Decade Hou
Packaging Quantity 4000		Insulation Resistance	10 GOhms

Т	0.85mm +/-0.1mm	Dielectric Withstanding Voltage	250 VDC
В	0.5mm +/-0.2mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Dissipation Factor	0.1%
Packaging	T&R, 180mm, Plastic Tape	Aging Rate	0% Loss/Decade Hour
Packaging Quantity 4000	Insulation Resistance	10 GOhms	
		Quality Factor	1000

**Specifications** Capacitance

Tolerance

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